

Digital Twin Pipeline for Rural, Smart City and AgriFood architectures

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Lead of BDVA/DAIRO TF6 Technical Priorities

Standards responsible in the DEMETER project



NGIoT Thematic Workshop: Rural Smart
Communities and Agrifood
March 30th, 2021

AI DATA ROBOTICS PARTNERSHIP EU



BDV BIG DATA VALUE
ASSOCIATION

DAIRO – Data, AI, Robotics

www.bdva.eu and <https://www.bdva.eu/task-force-6>

CLAIRE



ellis
European Institute for Learning and Intelligent Systems

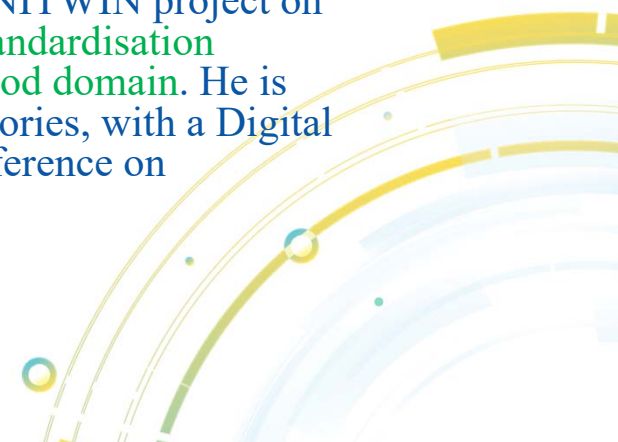
EurAi



Bio



- **Arne J. Berre** received his **Ph.D. in Computer Science (Dr. Ing)** from the Norwegian (NTNU) in 1993 on the topic of an **Object-oriented Framework for Systems Interoperability**. He is Chief Scientist at SINTEF Digital and Innovation Director at the Norwegian Center for AI Innovation (NorwAI), and responsible for the GEMINI center of Big Data and AI. He is the leader of the BDVA/DAIRO TF6 on Technical priorities including responsibilities for data technology architectures, data science/AI, data protection, standardisation, benchmarking and HPC. He has been in the technical lead of more than 20 European projects, including being responsible for the ATHENA Interoperability Framework and the BDVA Reference Model. He has been involved in the development of various standards for Interoperability - including Modeling for Geographic Information services with OGC, CEN/TC287 and ISO/TC211, ISO 19103, and been in lead in the standards development teams of the OMG standards of SoaML, VDML, General Ledger and Essence. He is the lead of the Norwegian committee for AI and Big Data with ISO SC 42 AI, and also involved in ISO SC41 IoT and Digital Twin. He has more than 100 scientific publications and has been involved in the organisation of a number of international conferences and workshops. He is the technical coordinator of the DataBench project on Big Data and AI Benchmarking and the COGNITWIN project on Cognitive and Hybrid Digital Twins for the process industry, and **responsible for the standardisation framework in the DEMETER project on Digital platform interoperability in the AgriFood domain**. He is working with SINTEF Ocean on the creation of an e-Infrastructure for Ocean Observatories, with a Digital Twin for the Ocean. He is the General co-chair for the BenchCouncil Bench'2021 Conference on Benchmarking for IoT, Edge, Big Data, AI and HPC.



Destination Earth (DestinE)

 [Translate this page](#)

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Implementation

Digital twins

Preparing for DestinE

Related links

The objective of the Destination Earth initiative is to develop a very high precision digital model of the Earth to monitor and simulate natural and human activity, and to develop and test scenarios that would enable more sustainable development and support European environmental policies.



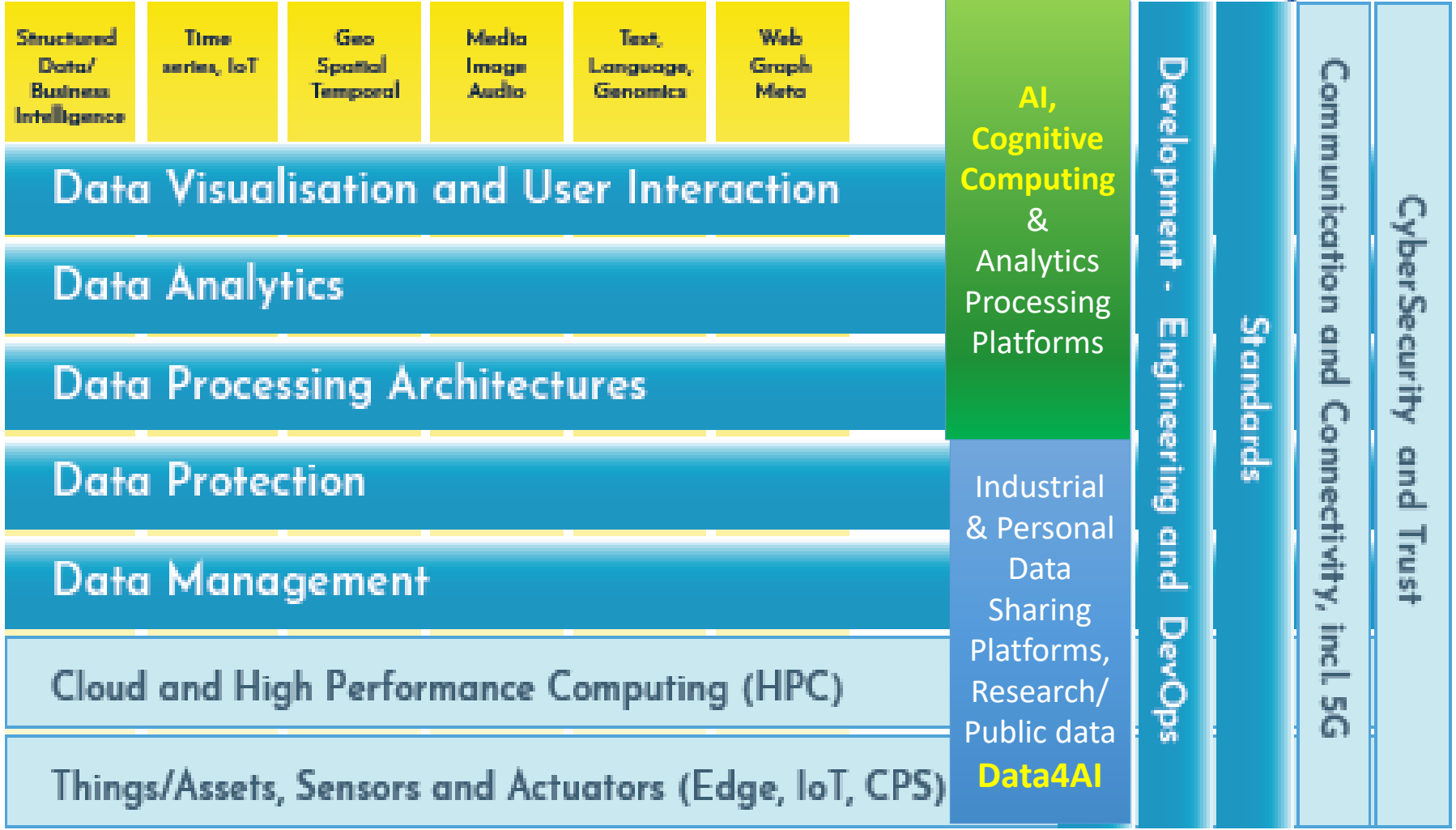
<https://ec.europa.eu/digital-single-market/en/destination-earth-destine>



bdva.eu
(Reference model)

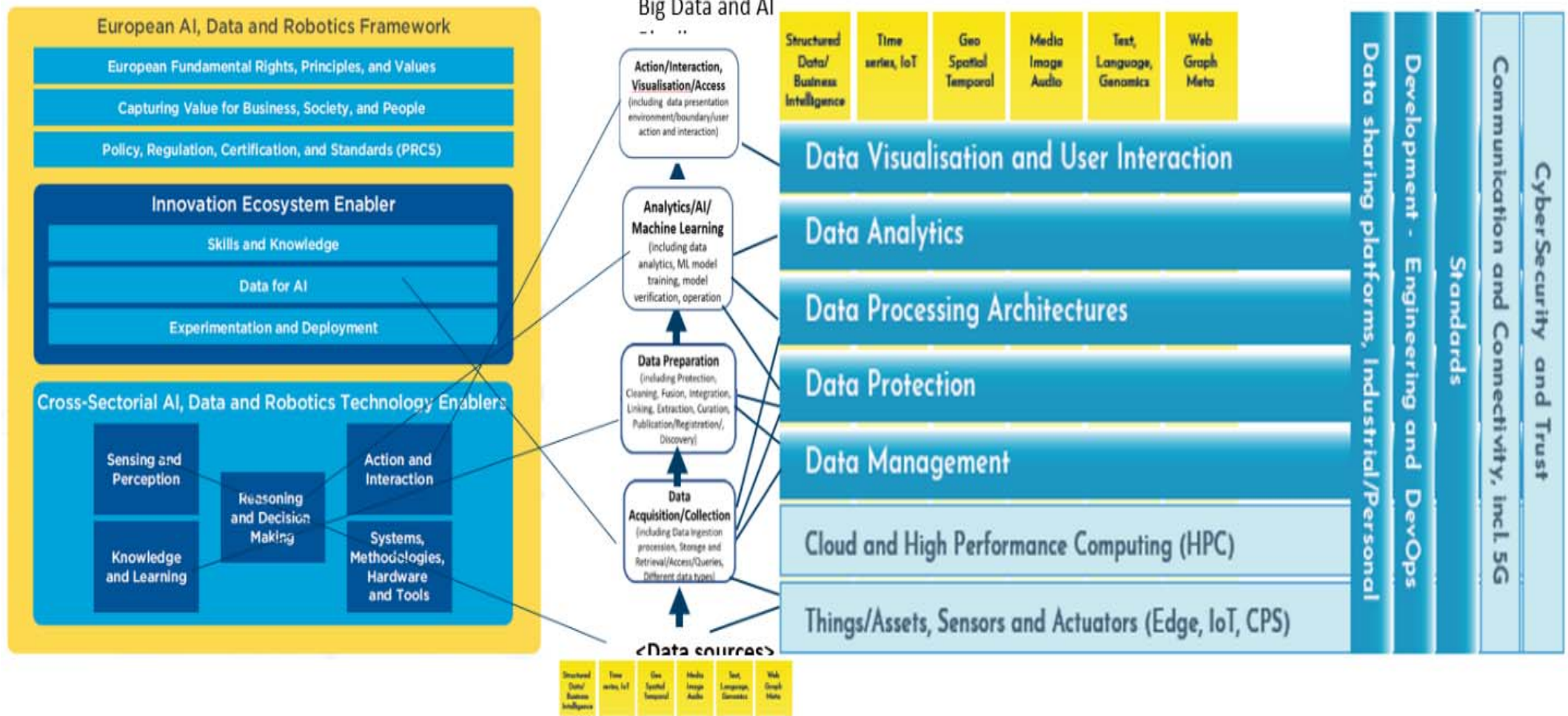
Data Science

Data Architecture



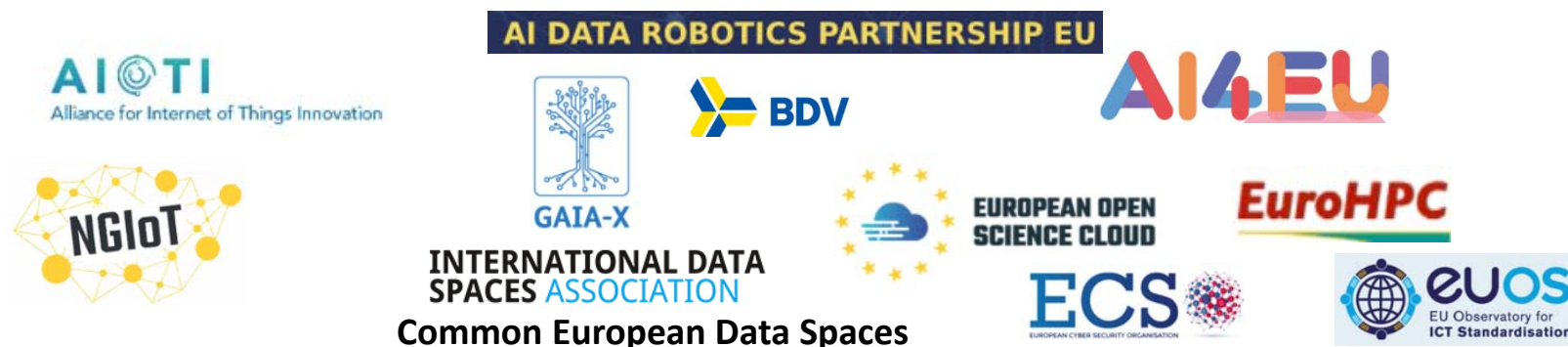
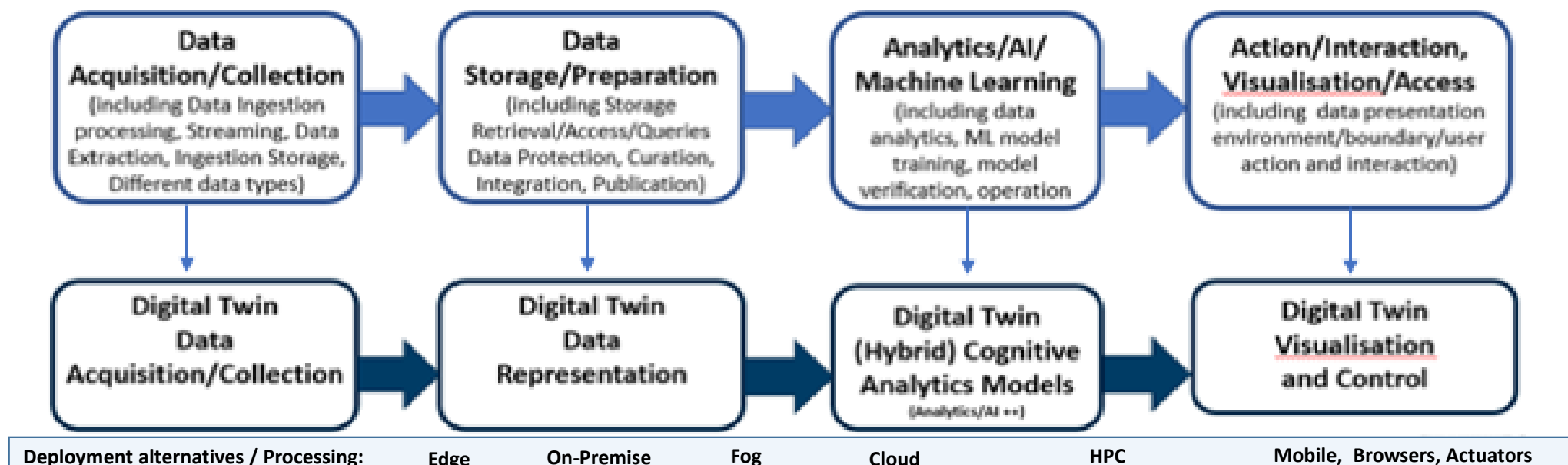
AI, Data and Robotics PPP Ecosystem model

BDVA Reference Model



Collaboration need: Data and Analytic/AI/HPC/Processing pipeline – Adapted for Digital Twins – execution at Edge, Fog, Cloud, HPC, Mobile

Note: All technologies are sometimes needed to be deployed at the Edge !



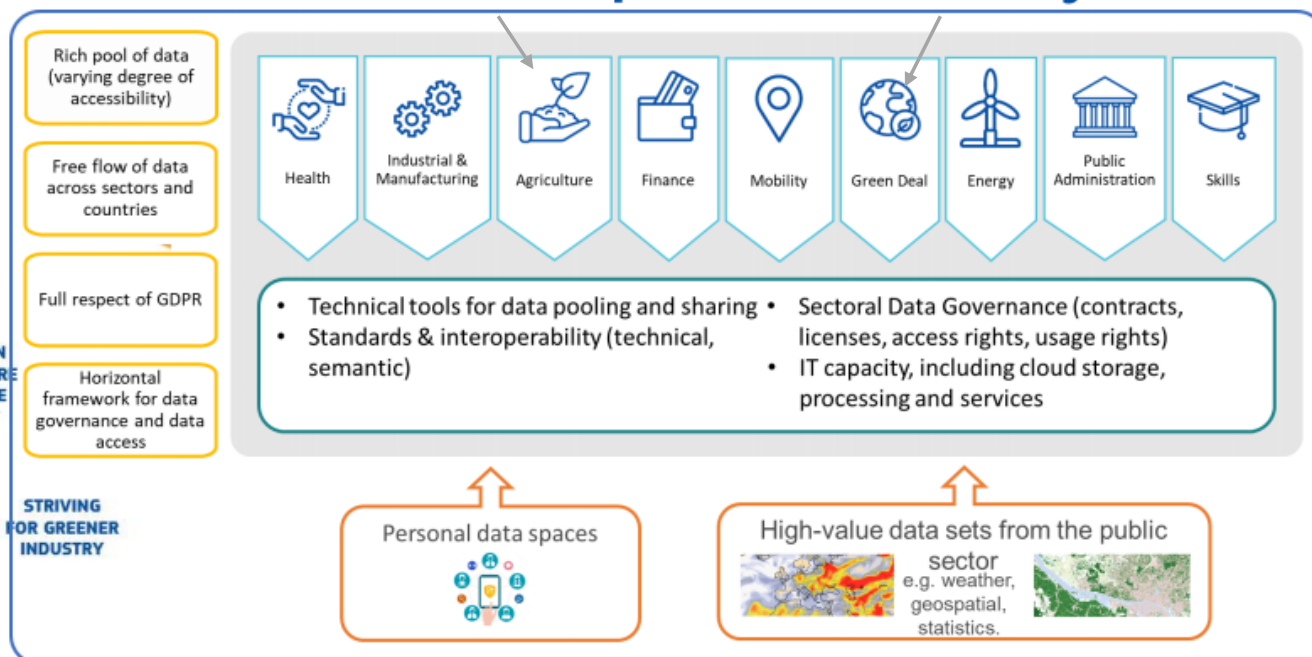
Focus areas of various European initiatives and PPPs

European Common Data Spaces

Interoperability between data spaces is key

A European Strategy for Data,
Feb. 19th, 2020

(Communication from the Commission)



-ref. EIF
Interoperability
levels



LOCATION (SpatioTemporal)
models is important
In most of the
FAIR data spaces

Digital Twin – Technology and Standards initiatives



- IDTA - Industrial Digital Twin Association (from Platform Industrie 4.0) – ref. AAS – Asset Administration Shell
- Digital Twin Consortium (with Microsoft DTDL – Digital Twin Definition Language ++)
- IIC – Industrial Internet Consortium (Digital Twin Interoperability Group)
- IDSA – International Data Spaces + GAIA-X
- ISO SC41 IoT and Digital Twin
- ISO SC42 AI (and Big Data)
- ISO 23247 – Digital Twin Manufacturing Framework
- ISO/TC211 + OGC – Open Geodata Consortium (Spatio Temporal), CityGML + ERDA
- ISO 19650 - BIM – Building Smart

Supported by European initiatives/PPPs: AIOTI + BDVA + AI-Data-Robotics + ECSO + EuroHPC

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Special Issue "Cognitive Digital Twins: Challenges and Opportunities for Process and Manufacturing Industries"

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A special issue of *Information* (ISSN 2078-2489). This special issue belongs to the section "Information and Communications Technology".

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Guest Editor

Fraunhofer IOSB, Germany

Interests: Industry 4.0; digital twins; knowledge engineering; IIoT architectural standards



Dr. Arne Jørgen Berre [E-Mail](#) [Website](#) [SciProfiles](#)

Guest Editor

SINTEF Digital, SINTEF AS

Interests: Big Data; AI; interoperability; ICT standards; reference architectures



2021 BenchCouncil International Symposium on Benchmarking, Measuring and Optimizing (Bench'21)

Nov 14-16, 2021

Benchmarking is Important to understand the performance of various technologies !

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Benchmarks on

- IoT
- Edge
- Big Data
- AI
- Architecture
- HPC
-

US + China - European interest ?

<https://www.benchcouncil.org/bench21>

AI DATA ROBOTICS PARTNERSHIP EU

<https://ai-data-robotics-partnership.eu/>

AIOTI

Alliance for Internet of Things Innovation

WG03 Standardisation

- **5G IA**, the 5G Infrastructure Association.
- **AIOTI**, the Alliance of Internet Of Things Innovation.
- **BDVA**, the Big Data Value Association.
- **CLAIRE**, the Confederation of Laboratories for Artificial Intelligence Research in Europe.
- **ECISO**, the European Cybersecurity Organisation.
- **ETP4HPC**, the European Technology Platform for High-Performance Computing.
- **EU-Maths-In**, the European Service Network of Mathematics for Industry and Innovation.
- **HiPEAC** project (High Performance Embedded Architecture and Compilation).



BDV BIG DATA VALUE ASSOCIATION



TCI

TransContinuum Initiative

The TransContinuum is the union of related digital technologies which offers solutions for the operation of complex data workflow systems. In this continuum, HPC plays a central role as the engine propelling AI, Big Data, IoT, Cybersecurity, and Mathematical components to work together.

The Transcontinuum Initiative, or TCI, is developing a vision of the characteristics of the infrastructure required for the convergence of data and compute capabilities in many leading edge industrial and scientific use scenarios. A paradigm change is needed: we will have to design systems encompassing millions of compute devices distributed over scientific instruments, IoT, supercomputers and Cloud systems through LAN, WLAN and 5G networks.

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